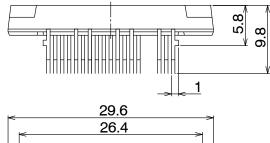


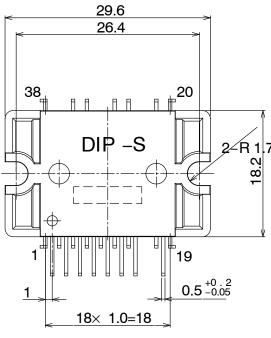
HYBRID INTEGRATED MODULE / DIP-S

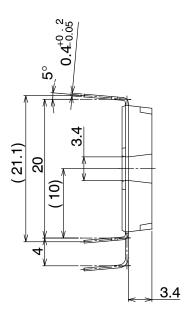
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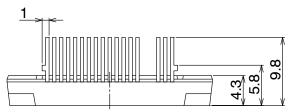
DATE 30 JUN 2012



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DESCRIPTION	HVBRID INTEGRATED MODILI E / DIP_S		DAGE 1 OF 1

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